

| | Type | Hits | Search Text | DBs | Time Stamp |
|----|------|------|--|---|------------------|
| 1 | BRS | 1389 | 428/64.1 | USPAT | 2004/04/02 14:29 |
| 2 | BRS | 85 | 428/64.1 | US-PGPU B; EPO; JPO; DERWENT ; IBM_TDB | 2004/04/01 18:13 |
| 3 | BRS | 4 | 428/66.7 | US-PGPU B; EPO; JPO; DERWENT ; IBM_TDB | 2004/04/01 18:14 |
| 4 | BRS | 118 | 428/66.7 | USPAT | 2004/04/01 18:14 |
| 5 | BRS | 132 | optical near disk with semiconductor near wafer | USPAT | 2004/04/02 14:55 |
| 6 | BRS | 4553 | optical near disk with semiconductor | USPAT | 2004/04/02 14:55 |
| 7 | BRS | 160 | optical near disk with semiconductor with material | USPAT | 2004/04/02 14:56 |
| 8 | BRS | 65 | (optical near disk with semiconductor with material) and optical near disk with (mad\$3 or form\$3) with semiconductor with material | USPAT | 2004/04/02 14:58 |
| 9 | BRS | 10 | (optical near disk with semiconductor with material) and optical near disk with (mad\$3 or form\$3) with semiconductor near material | USPAT | 2004/04/02 14:58 |
| 10 | BRS | 2 | (bismuth near silicate) with semiconductor adj material | USPAT | 2004/04/02 16:42 |
| 11 | BRS | 0 | alphanumeric near characters with Barker adj code | USPAT | 2004/04/02 16:43 |
| 12 | BRS | 0 | alphanumeric near characters same Barker adj code | USPAT | 2004/04/02 16:44 |
| 13 | BRS | 0 | alphanumeric same Barker adj code | USPAT | 2004/04/02 16:44 |

| | Type | Hits | Search Text | DBs | Time Stamp |
|----|------|------|---|---|-------------------------|
| 14 | BRS | 9 | characters same Barker adj code | USPAT | 2004/0 4/02 18:34 |
| 15 | BRS | 976 | 257/797 | USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM_TDB | 2004/0 4/02 18:35 |
| 16 | BRS | 228 | (257/618 or 257/619 or 257/620) and wafer with (cod\$3 or mark\$3 or align\$5) | USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM_TDB | 2004/0 4/04 20:04 |
| 17 | BRS | 156 | (257/621 or 257/622 or 257/623) and wafer with (cod\$3 or mark\$3 or align\$5) | USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM_TDB | 2004/0 4/04 20:37 |
| 18 | BRS | 26 | (257/624 or 257/625 or 257/626) and wafer with (cod\$3 or mark\$3 or align\$5) | USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM_TDB | 2004/0 4/04 20:39 |
| 19 | BRS | 66 | (257/627 or 257/628 or 257/626) and wafer with (cod\$3 or mark\$3 or align\$5) | USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM_TDB | 2004/0 4/04 20:39 |
| 20 | BRS | 63 | (257/627 or 257/628 or 257/629) and wafer with (cod\$3 or mark\$3 or align\$5) | USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM_TDB | 2004/0 4/04 21:05 |
| 21 | BRS | 735 | 257/618 | USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM_TDB | 2004/0 4/04 21:21 |

| | Type | Hits | Search Text | DBs | Time Stamp |
|----|------|------|-------------|---|-------------------------|
| 22 | BRS | 178 | 257/619 | USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM_TDB | 2004/0 4/04 21:23 |
| 23 | BRS | 781 | 257/620 | USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM_TDB | 2004/0 4/04 21:38 |
| 24 | BRS | 1592 | 257/622 | USPAT; US-PGPU B; EPO; JPO; DERWENT ; IBM_TDB | 2004/0 4/04 21:39 |